

# 4A, 50V - 1000V Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High current capability
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

<b>APF</b>	PLICA	TIONS
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- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- General purpose

#### **MECHANICAL DATA**

• Case: DO-214AB (SMC)

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

• Polarity: Indicated by cathode band

• Weight: 0.210g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l <sub>F</sub>	4	Α		
$V_{RRM}$	50 - 1000	V		
I <sub>FSM</sub>	100	Α		
$T_{JMAX}$	150	°C		
Package	DO-214AB (SMC)			
Configuration	Single die			









DO-214AB (SMC)



	SYMBOL	<b>S4</b>	<b>S4</b>	<b>S4</b>	<b>S4</b>	<b>S4</b>	<b>S4</b>	<b>S4</b>	UNIT
PARAMETER		AH	ВН	DH	GH	JH	KH	МН	
Marking code on the device		S4A	S4B	S4D	S4G	S4J	S4K	S4M	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>				4				Α
Peak forward surge current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub> 100			А					
Junction temperature	TJ	T <sub>J</sub> - 55 to +150			°C				
Storage temperature	T <sub>STG</sub> - 55 to +150			°C					

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	13	°C/W	
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	47	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 4A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.15	V
Deviation of the stand V (2)	T <sub>J</sub> = 25°C		-	10	μA
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	250	μA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	60	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A,$ $I_{rr} = 0.25A$	t <sub>rr</sub>	1500	-	ns

# Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S4xH	DO-214AB (SMC)	3,000 / Tape & Reel		

### Notes:

1. "x" defines voltage from 50V(S4AH) to 1000V(S4MH)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

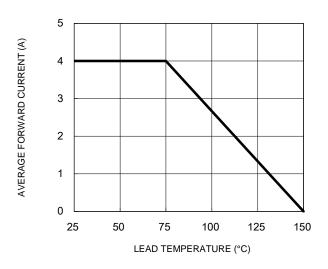


Fig.3 Typical Reverse Characteristics

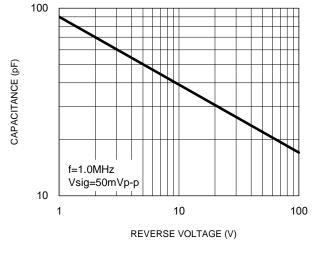
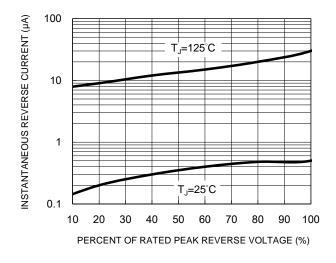


Fig.2 Typical Junction Capacitance

**Fig.4 Typical Forward Characteristics** 



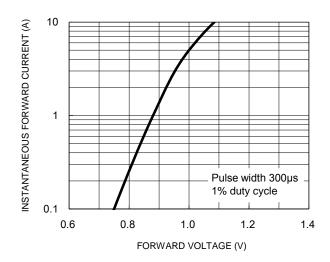
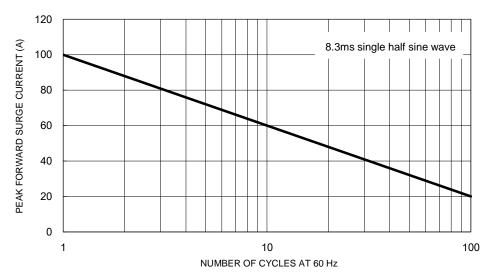
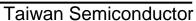


Fig.5 Maximum Non-Repetitive Forward Surge Current



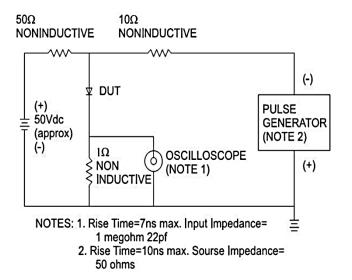


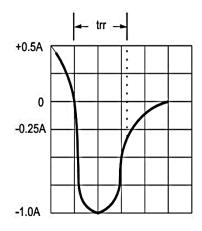


### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

### Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram



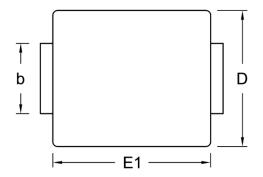


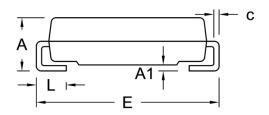




# **PACKAGE OUTLINE DIMENSIONS**

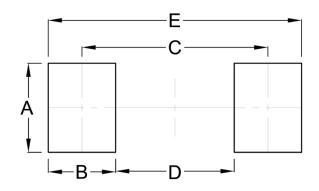
# DO-214AB (SMC)





DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	2.00	2.62	0.079	0.103	
A1	0.10	0.20	0.004	0.008	
b	2.90	3.20	0.114	0.126	
С	0.15	0.31	0.006	0.012	
D	5.59	6.22	0.220	0.245	
E	7.75	8.13	0.305	0.320	
E1	6.60	7.11	0.260	0.280	
L	1.00	1.60	0.039	0.063	

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	3.30	0.130
В	2.50	0.098
С	6.90	0.272
D	4.40	0.173
E	9.40	0.370

## **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

ΥW = Date Code F = Factory Code



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